

Issued: Sept. 2006 Revision: July 2016, Page: 1	<b>EP 145/EPC 145</b> High Filled Epoxy Compound for Potting and Encapsulation			
Product Description	EP 145/EPC 145 is a high filled, moderate viscosity, low temperature cur epoxy compound for potting and encapsulation, exhibiting high mechani and electrical insulating properties, suitable for prolong pot life application			
Features & Benefits	• Low shrinkage • High filled		filled	
	• Room temperature cured • Long pot life		pot life	
	• Moderate viscosity • High penetration		penetration	
Applications	Encapsulation and potting of electrical and electronic components.			
Typical Uncured Properties	Note: The following technical information and data should be considered representative or typical only and should not be used for specification purposes.			
	Base Resins	Base (A) Hardener (B)	Epoxy Compound Cycloaliphatic Amines	
	Appearance/Color	Base (A) Hardener (B)	black clear	
	Viscosity, per ASTM-D-2393, mPa*s @25°C	Base (A) Hardener (B) Mixed A+B	50000 45 6000	
	per ASTM-D-2393,	Hardener (B)	45	

**Instructions for use:** 

Weigh required amount of resin and hardener into a clean container in the recommended ratio. Blend thoroughly being careful to scrape sides and bottom of the container for 3-4 minutes to ensure uniform mixture. To produce a void-free casting the mixture should be deairing at 2-5 mmHg for 5-10 minutes to remove trapped air

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Mechanical		
	Color	black
	<b>Pot-life</b> @ 25°C, (100g), min	120-150
	Gel-time @ 25°C, (100g), min	260
	De-mold @ 25°C, hr	24
	Final curing @ 25°C, days	7
	Hardness, Shore D (after 7 days)	85
	Tensile Strength, MPa	53
	Tensile Elongation, %	0.8-1.0
	Flexural Strength, MPa	76
	Flexural Modulus, MPa	7200
	Linear Shrinkage, %	0.2-0.3
	Heat Distortion Point, °C	62
	Service Temperature, °C	-40 to 130

crystallization occurs, warm the container to 50-60°C until the crystals<br/>have dissolved.<br/>Stir and allow content to cool to room temperature before use.Limitation of LiabilityExcept where prohibited by law, Polymer-G and seller will not be liable for<br/>any loss or damage arising from the Polymer-G product whether direct

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